

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF CLAIMS:

Claims 1-10 (canceled).

Claim 11 (new): An electrical contact component comprising:

a base to be mounted on a surface of a mounting board with a solder, the base having a first principal surface opposing the surface of the mounting board, a second principal surface substantially parallel to the first principal surface, and sides substantially perpendicular to the first and second principal surfaces and connecting the first principal surface to the second principal surface; and

a fitting portion continuously provided on the second principal surface, the fitting portion having a substantially tubular shaped fitting periphery; wherein

the fitting periphery of the fitting portion is electrically connected to the second principal surface and the sides of the base by metal films provided over their respective surfaces; and

the metal films each include a first metal layer containing Ni as a principal constituent and Co, and a second metal layer containing Au as a principal constituent and overlying the first metal layer.

Claim 12 (new): The electrical contact component according to Claim 11, wherein the base defines an external terminal and is integrated with the fitting portion, and the second principal surface is partitioned from the sides by an edge line.

Claim 13 (new): The electrical contact component according to Claim 11, wherein the Co content in the first metal layer is in the range of about 5 to about 80 percent by weight.

Claim 14 (new): The electrical contact component according to Claim 11, wherein the Co content in the first metal layer is in the range of about 10 to about 80 percent by weight.

Claim 15 (new): The electrical contact component according to Claim 11, wherein at least one of the first metal layer and the second metal layer is provided by plating.

Claim 16 (new): The electrical contact component according to Claim 11, wherein the first metal layer is provided by cladding.

Claim 17 (new): The electrical contact component according to Claim 11, wherein both of the first metal layer and the second metal layer are provided by cladding.

Claim 18 (new): The electrical contact component according to Claim 11, wherein the fitting portion has a substantially cylindrical shape and protrudes from the second principal surface.

Claim 19 (new): A coaxial connector comprising the electrical contact component according to Claim 11.

Claim 20 (new): An electrical circuit device comprising:

the electrical contact component according to Claim 11; and

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a wiring board on which the base is surface-mounted with a Sn-based solder.

Claim 21 (new): The electrical circuit device according to Claim 20, wherein the Sn-based solder includes Ag and substantially no Pb.

Claim 22 (new): An electrical circuit device comprising:

the coaxial connector according to Claim 18; and

a wiring board on which the base is surface-mounted with a Sn-based solder.

Claim 23 (new): The electrical circuit device according to Claim 22, wherein the Sn-based solder includes Ag and substantially no Pb.

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